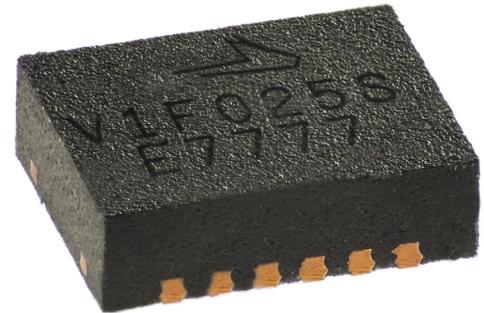


CGHV1F025S

25 W, DC - 15 GHz, 40 V, GaN HEMT

Description

WolfSpeed's CGHV1F025S is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities. The device can be deployed for L-, S-, C-, X- and Ku-Band amplifier applications. The datasheet specifications are based on a X-Band (8.9 - 9.6 GHz) amplifier. The CGHV1F025S operates on a 40 volt rail circuit while housed in a 3mm x 4mm, surface mount, dual-flat-no-lead (DFN) package. Under reduced power, the transistor can operate below 40V to as low as 20V V_{DD} , maintaining high gain and efficiency.



Package Type: 3x4 DFN
PN: CGHV1F025S

Typical Performance 8.9 - 9.6 GHz ($T_c = 25^\circ\text{C}$), 40 V

Parameter	8.9 GHz	9.2 GHz	9.4 GHz	9.6 GHz	Units
Output Power @ $P_{IN} = 37$ dBm	24	29	27	25	W
Drain Efficiency @ $P_{IN} = 37$ dBm	43.5	48.5	48	46	%
Gain @ $P_{IN} = 0$ dBm	10.7	11.6	11.3	11.1	dB

Note:
Measured in the CGHV1F025S-AMP1 application circuit. Pulsed 100 μ s 10% duty

Features

- Up to 15 GHz Operation
- 25 W Typical Output Power
- 11 dB Gain at 9.4 GHz
- Application circuit for 8.9 - 9.6 GHz

 Large Signal Models Available for ADS and MWO





Absolute Maximum Ratings (not simultaneous) at 25°C

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DSS}	120	V	25°C
Gate-to-Source Voltage	V_{GS}	-10, +2		
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225		
Maximum Forward Gate Current	I_{GMAX}	4.8	mA	25°C
Maximum Drain Current ¹	I_{DMAX}	2	A	
Soldering Temperature ²	T_S	245	°C	
Case Operating Temperature ^{3,4}	T_C	-40, +150		
Thermal Resistance, Junction to Case ⁵	$R_{\theta JC}$	3.4	°C/W	85°C

Notes:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at wolfspeed.com/rf/document-library

³ Simulated at $P_{DISS} = 24$ W

⁴ T_C = Case temperature for the device. It refers to the temperature at the ground tab underneath the package. The PCB will add additional thermal resistance

⁵ Pulsed (100µs, 10% Duty). Rth for Wolfspeed's reference design using a 10 mil Rogers 5880 PCB with 31 (Ø13 mil) Vias would be 3.6°C/W. For CW operation the Rth numbers increase to 5°C/W for just the device, and 7.3°C/W including the board

Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	$V_{DS} = 10$ V, $I_D = 4.8$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	–	-2.7	–		$V_{DS} = 40$ V, $I_D = 120$ mA
Saturated Drain Current ²	I_{DS}	3.5	4.8	–	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	100	–	–	V_{DC}	$V_{GS} = -8$ V, $I_D = 4.8$ mA
RF Characteristics³ ($T_C = 25^\circ\text{C}$, $F_0 = 5.55$ GHz unless otherwise noted)						
Gain	G	–	15.1	–	dB	$V_{DD} = 40$ V, $I_{DQ} = 120$ mA, $P_{IN} = 10$ dBm
Output Power ⁴	P_{OUT}	–	44.8	–	dBm	$V_{DD} = 40$ V, $I_{DQ} = 120$ mA, $P_{IN} = 33.5$ dBm
Drain Efficiency ⁴	η	–	51	–	%	
Output Mismatch Stress ⁴	VSWR	–	–	10:1	Ψ	No damage at all phase angles, $V_{DD} = 40$ V, $I_{DQ} = 120$ mA, $P_{IN} = 33.5$ dBm
Dynamic Characteristics						
Input Capacitance	C_{GS}	–	5.9	–	pF	$V_{DS} = 40$ V, $V_{GS} = -8$ V, $f = 1$ MHz
Output Capacitance	C_{DS}	–	2	–		
Feedback Capacitance	C_{GD}	–	0.21	–		

Notes:

¹ Measured on wafer prior to packaging

² Scaled from PCM data

³ Measured in production test fixture.

⁴ Pulsed 100µs, 10% duty cycle

⁵ Includes package



Electrical Characteristics When Tested in CGHV1F025S-AMP1

Characteristics	Symbol	Typ.	Max.	Units	Conditions
RF Characteristics¹ ($T_c = 25^\circ\text{C}$, $F_0 = 8.9 - 9.6 \text{ GHz}$ unless otherwise noted)					
Gain	G	11.6	—	dB	$V_{DD} = 40 \text{ V}$, $I_{DQ} = 150 \text{ mA}$, $P_{IN} = 0 \text{ dBm}$
Output Power ²	P_{OUT}	29	—	W	$V_{DD} = 40 \text{ V}$, $I_{DQ} = 150 \text{ mA}$, $P_{IN} = 37 \text{ dBm}$
Drain Efficiency ²	η	48.5	—	%	
Output Mismatch Stress ²	VSWR	—	10:1	Ψ	$V_{DS} = 40 \text{ V}$, $V_{GS} = -8 \text{ V}$, $P_{OUT} = 25 \text{ W}$

Notes:

¹ Measured in CGHV1F025S-AMP1 Application Circuit

² Pulsed 100 μs , 10% duty cycle

Typical Performance - CGHV1F025S

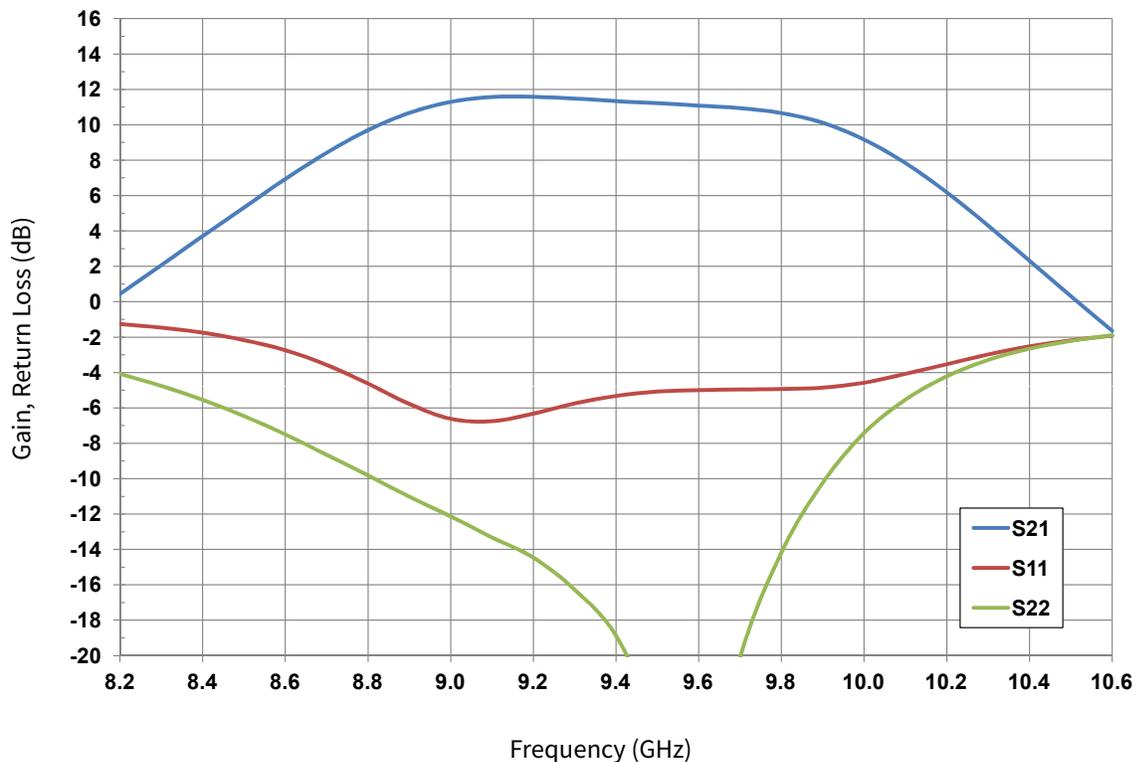


Figure 1. Typical Small Signal Response of CGHV1F025S-AMP1 Application Circuit
 $V_{DD} = 40 \text{ V}$, $I_{DQ} = 150 \text{ mA}$



Typical Performance in Application Circuit CGHV1F025S-AMP1

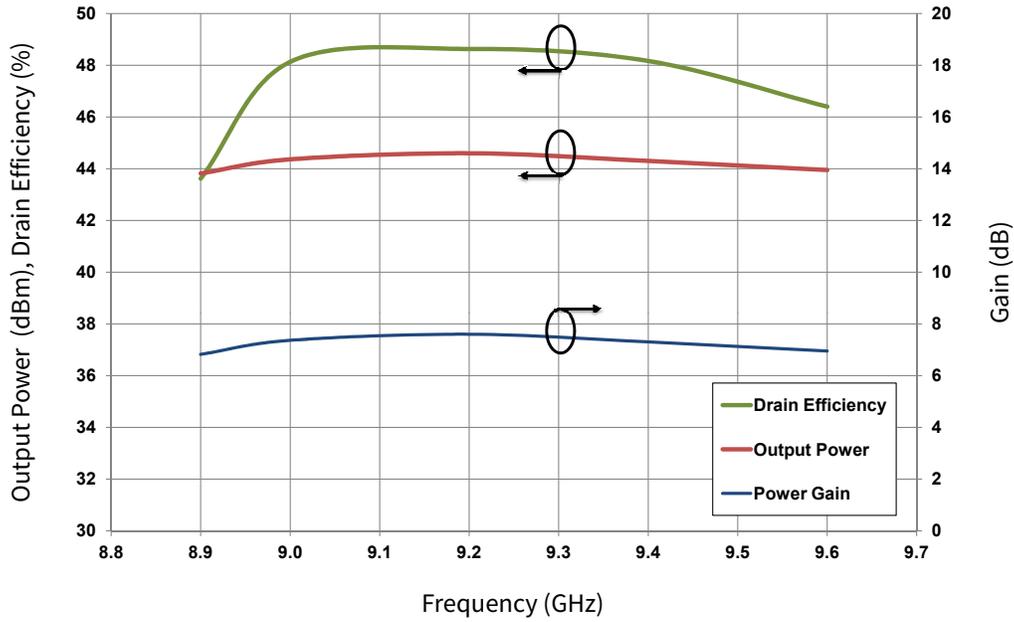


Figure 2. Typical Large Signal Response
 $V_{DD} = 40\text{ V}$, $I_{DQ} = 150\text{ mA}$, $P_{IN} = 37\text{ dBm}$
 $T_{CASE} = 25^\circ\text{C}$, Pulse Width = $100\mu\text{s}$, Duty Cycle = 10%

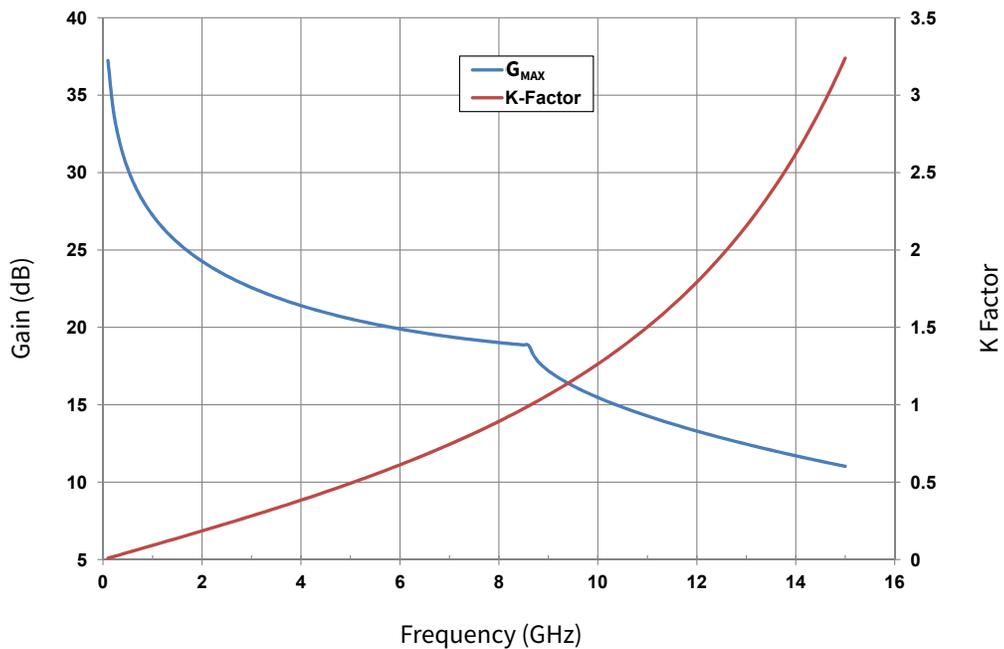
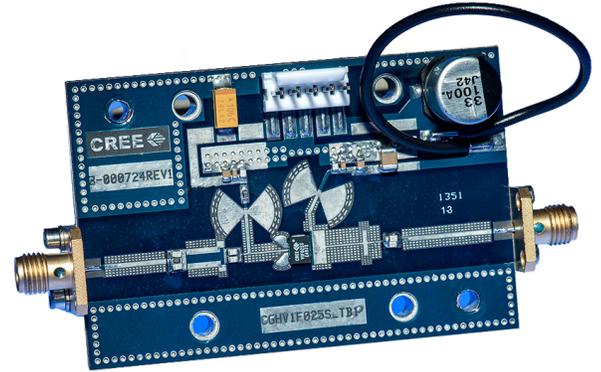


Figure 3. G_{MAX} and K-Factor vs Frequency
 $V_{DD} = 40\text{ V}$, $I_{DQ} = 150\text{ mA}$, $T_{CASE} = 25^\circ\text{C}$

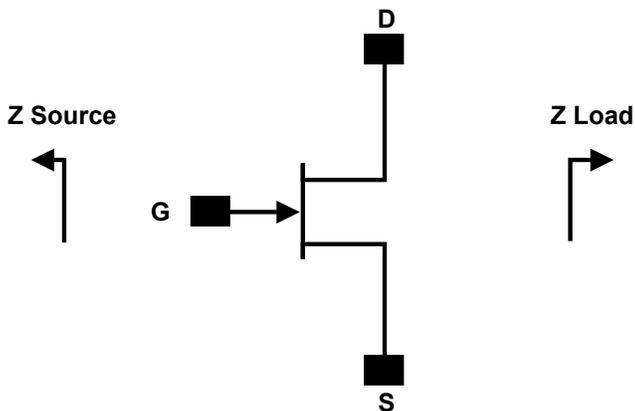
CGHV1F025S-AMP1 Application Circuit Bill of Material

Designator	Description	Qty
R1	RES, 100, OHM, +/-1%, 1/16 W, 0603	2
R2	RES, 10, OHM, +/-1%, 1/16 W, 0603	1
C1, C2	CAP, 1pF, ±0.1pF, 0603, ATC	3
C3, C4	CAP, 1.8pF, ±0.1pF, 0603, ATC	3
C9, C10	CAP, 0.6pF, ±0.1pF, 0603, ATC	1
C5, C11	CAP, 10pF, ±5%, 0603, ATC	1
C6, C12	CAP, 470pF, 5%, 100 V, 0603, X	2
C7, C13	CAP, 33000pF, 0805, 100V, X7R	1
C14	CAP, 1.0μF, 100V, 10%, X7R, 1210	3
C8	CAP, 10μF, 16V TANTALUM	3
C15	CAP, 33μF, 20%, G CASE	1
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE	1
J3	HEADER RT>PLZ .1CEN LK 5POS	2
Q1	QFN TRANSISTOR CGHV1F025S	1
W1	CABLE, 18 AWG, 4.2	1

CGHV1F025S-AMP1 Application Circuit



Source and Load Impedances



Frequency (GHz)	Z Source	Z Load
8.00	1.16 - j12.0	4.33 - j3.47
8.25	1.12 - j12.92	4.20 - j4.34
8.50	0.96 - j13.39	3.37 - j5.23
8.75	1.07 - j14.33	3.50 - j6.11
9.00	1.06 - j14.80	3.45 - j6.99
9.25	1.15 - j15.76	3.38 - j7.44
9.50	1.17 - j16.24	3.31 - j7.89
9.75	1.14 - j17.21	3.25 - j8.78
10.00	1.30 - j17.70	3.21 - j9.23



Electrostatic Discharge (ESD) Classifications

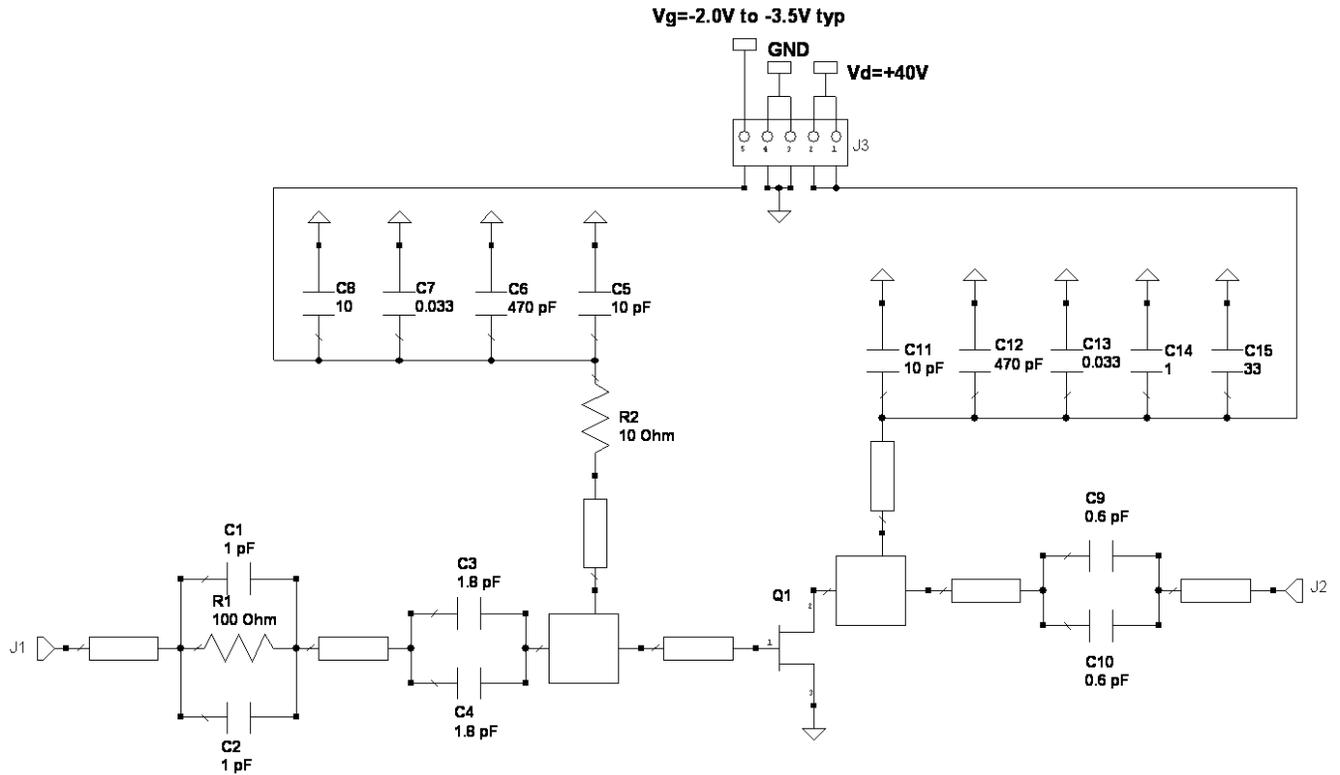
Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	1A	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	C3	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

Moisture Sensitivity Level (MSL) Classification

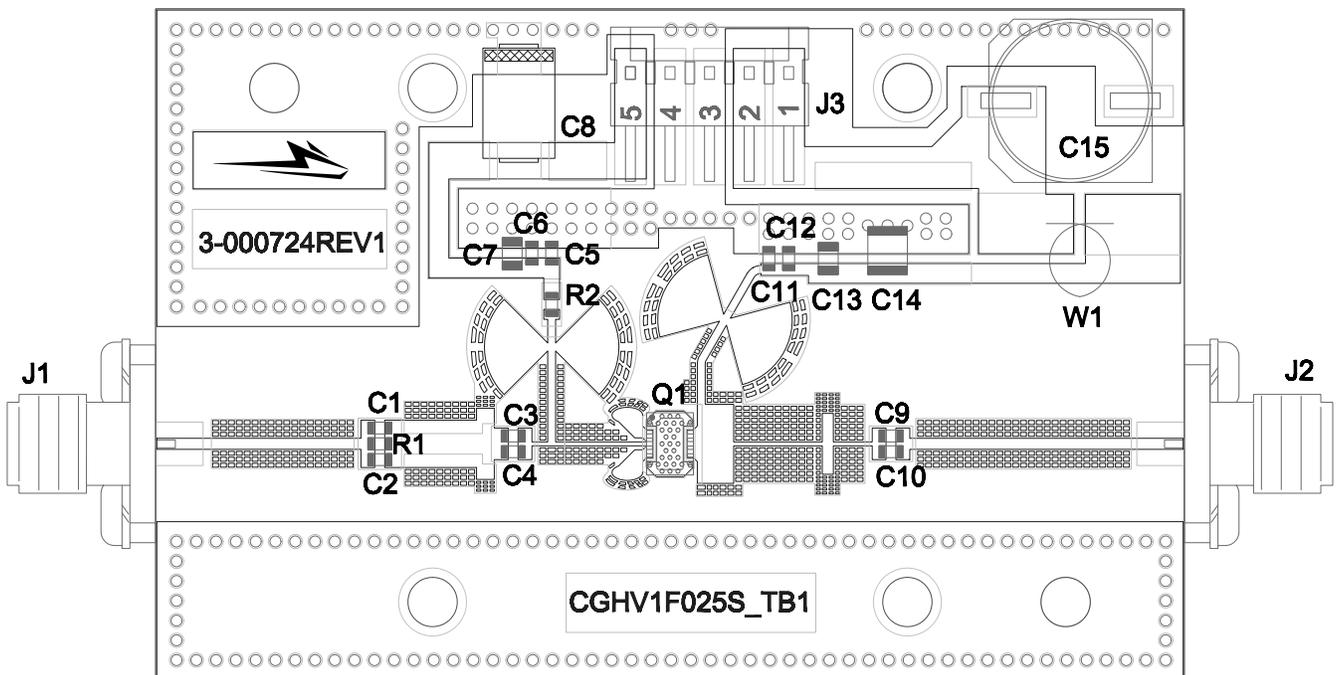
Parameter	Symbol	Level	Test Methodology
Moisture Sensitivity Level	MSL	3 (168 hours)	IPC/JEDEC J-STD-20



CGHV1F025S-AMP1 Application Circuit Schematic



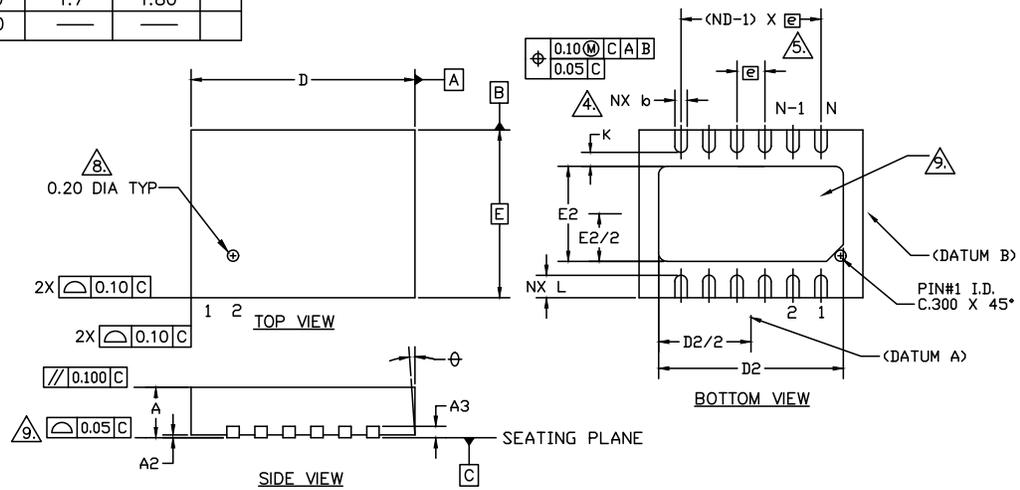
CGHV1F025S-AMP1 Application Circuit Outline



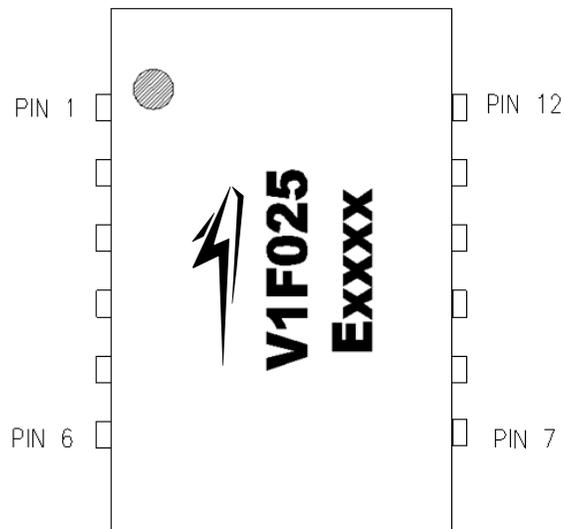


Product Dimensions CGHV1F025S (Package 3 x 4 DFN)

SYMBOL	COMMON DIMENSIONS			NOTE
	MIN.	NOM.	MAX.	
A	0.80	0.90	1.0	
A1	0.00	0.02	0.05	
A3	0.203 REF.			
⌀	0	—	12	2
D	4.00 BSC			
E	3.00 BSC			
Ⓜ	0.50 BSC			
N	12			3
ND	6			▲
L	0.35	0.40	0.45	
b	0.18	0.25	0.30	▲
D2	3.20	3.30	3.40	
E2	1.60	1.7	1.80	
K	0.20	—	—	



Frequency	Z Source
1	GND
2	RF IN
3	RF IN
4	RF IN
5	RF IN
6	GND
7	GND
8	RF OUT
9	RF OUT
10	RF OUT
11	RF OUT
12	GND



Note: Leadframe finish for 3x4 DFN package is Nickel/Palladium/Gold. Gold is the outer layer



Part Number System

CGHV1F025S



Table 1.

Parameter	Value	Units
Upper Frequency ¹	15.0	GHz
Power Output	25	W
Package	Surface Mount	—

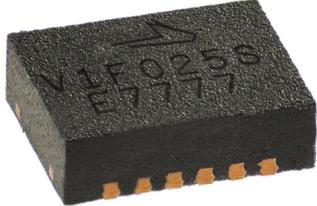
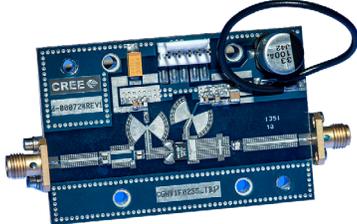
Note:

¹ Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Table 2.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples	1A = 10.0 GHz 2H = 27.0 GHz

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV1F025S	GaN HEMT	Each	
CGHV1F025-AMP1	Test board with GaN HEMT installed	Each	

**For more information, please contact:**

4600 Silicon Drive
Durham, NC 27703 USA
Tel: +1.919.313.5300
www.wolfspeed.com/RF

Sales Contact
RFSales@wolfspeed.com

RF Product Marketing Contact
RFMarketing@wolfspeed.com

Notes & Disclaimer

Specifications are subject to change without notice. “Typical” parameters are the average values expected by Wolfspeed in large quantities and are provided for information purposes only. Wolfspeed products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death. No responsibility is assumed by Wolfspeed for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Wolfspeed.

©2014-2022 Wolfspeed, Inc. All rights reserved. Wolfspeed® and the Wolfstreak logo are registered trademarks and the Wolfspeed logo is a trademark of Wolfspeed, Inc.
PATENT: <https://www.wolfspeed.com/legal/patents>

The information in this document is subject to change without notice.